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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Frank A. Baiocchi  
Application No: 10/673,539  
Filed: 09/29/2009  
Art Unit: 2818  
Docket No.: TI-68031  
Conf. No.: 1844

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NAME OF INVENTOR(S):	
<b>Frank A. Baiocchi</b>	
TITLE OF INVENTION:	
Metal-Oxide-Semiconductor Device With Enhanced Source Electrode	
TI FILE NO.:	DEPOSIT ACCT. NO.:
<b>TI-68031</b>	<b>20-0668</b>
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<b>Serial No.: 10/673,539</b>	
<b>Filing Date: 09/29/2009</b>	

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